

L Number	Hits	Search Text	DB	Time stamp
1	2	("5756380").PN.	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 12:00
2	597	(mold or molded or molding) same (insulating adj substrate)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:06
3	9	molded adj insulating adj substrate	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 12:05
4	8	("5102712" "5173840" "5208728" "5461256" "5719746" "5735040" "5867371" "5962840").PN.	USPAT	2003/04/06 12:03
5	39239	(insulative or insulating) adj substrate	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 12:07
6	1	((insulative or insulating) adj substrate) and (charge adj resin)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 13:31
7	2	("5866952").PN.	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 12:33
8	10	("4635356" "4783695" "4897153" "5073814" "5108825" "5157589" "5161093" "5270371" "5300812" "5353498").PN.	USPAT	2003/04/06 12:20
9	76	5353498.URPN.	USPAT	2003/04/06 12:23
10	11	("5353498" "5422513" "5455457" "5497033" "5514906" "5527741" "5703400" "5745984" "5895229" "6154366" "6184570").PN.	USPAT	2003/04/06 12:28
11	85	((mold or molded or molding) same (insulating adj substrate)) and embedded	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 12:33
12	0	((("5756380").PN.) and (charge adj resin)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 13:57
13	379	((mold or molded or molding) same (insulating adj substrate)) and resin	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 13:58
14	2391	(mold or molded or molding) adj substrate	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:08
15	0	((mold or molded or molding) adj substrate) and (capacitor near embedded)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:09
16	47	((mold or molded or molding) adj substrate) and capacitor	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:09
17	16	((((mold or molded or molding) adj substrate) and capacitor) and (charge or fill)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:15
18	229	((mold or molded or molding) adj substrate) and embedded	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:14

19	62	(((mold or molded or molding) adj substrate) and embedded) and (charge or fill)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:15
20	134	(((mold or molded or molding) adj substrate) and embedded) and (charge or chagred or charging or fill or filled or filling)	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:16
21	84	(((mold or molded or molding) adj substrate) and embedded) and (charge or chagred or charging or fill or filled or filling)) and resin	USPAT; EPO; JPO; DERWENT; USOCR	2003/04/06 14:16